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Docket No.: M1071.1711/P1711

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Hidekiyo Takaoka, et al.

Application No.: 10/087,742

Art Unit: 1742

Filed: March 5, 2002

Examiner: S. Ip

For: LEAD FREE SOLDER AND SOLDERED

ARTICLE

## AMENDMENT IN RESPONSE TO FINAL OFFICE ACTION

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

## **INTRODUCTORY COMMENTS**

In response to the Office Action dated January 30, 2003, please reconsider the above-identified U.S. patent application in light of the following remarks:

## FEE CALCULATION

Any additional fee required has been calculated as follows:

\_\_\_\_ If checked, Small Entity status is claimed